

## **TOPFLIGHT INNOVATIONS**

# *Thermal Transfer Imprintable Labels*

## ***Including high temperature polyimide labels!***

Currently one of the most popular methods for labeling with sequential or variable information is thermal transfer imprinting. The process is generally less time consuming and less costly than other techniques, and offers maximum flexibility and quality. Topflight has many material constructions already designed and approved to utilize this technology. Labels can be produced with our entire array of printing and converting equipment and expertise to supply any shape, size, and configuration. The labels can then be delivered ready for imprinting, or if so desired, can arrive already thermally imprinted by Topflight Corporation, ready for staging and final application.

To address the performance requirements of high temperature component assembly lines, Topflight offers the same range of design deliveries for polyimide labels. These labels can withstand temperatures up to 540°C (1000°F) as well as various fluxes, solvents, cleaners, and saponifiers. For more information or to obtain material samples for testing and verification, please contact a sales or customer service representative.



*Topflight offers a number of materials suitable for thermal transfer imprinting, most already UL and CSA approved.*



*Extreme temperature and environmental durability is achieved with polyimide labels, perfect for bar coding or labeling PC boards and other electronic components.*